DULTRA MICRO DULTRA MICRO POWER SYSTEM (2.00 mm) .0787" PITCH



FEATURES & BENEFITS

- Board-to-board, cable-to-board and cable-to-cable
- Up to 18 A per blade (1 blade powered)

- Choice of 2 to 10 positions
- 5 mm to 20 mm stack heights; vertical and right-angle orientations
- Tin or 10 $\mu^{\rm "}$ Gold plated power blades; 30 $\mu^{\rm "}$ Gold plating available to meet specific regulations
- Optional weld tabs
- Mating cable assemblies with plastic top or metal side latching
- Severe Environment Testing qualified (UMPT/UMPS); aligns with MIL-DTL-55302. Visit samtec.com/set

KEY SPECIFICATIONS (UMPT/UMPS)

CURRENT RATING (PER CONTACT)

-11111111

UMPT/UMPS							
PINS	-т	-L					
1	17.8 A	17.5 A					
2	15.5 A	16.3 A					
3	13.5 A	13.9 A					
4	12.9 A	13.2 A					
10	9.8 A	8.9 A					

Ratings are derated 20% with 30 $^{\circ}\mathrm{C}$ rise to maximum allowable temperature.

CREEPAGE & CLEARANCE

UMPT/UMPS				
CREEPAGE	2.20 mm			
CLEARANCE	1.65 mm			

Selectively loading contacts achieves customer specific creepage and clearance requirements.

STACK HEIGHTS	INSULATOR MATERIAL	CONTACT MATERIAL	PLATING	OPERATING TEMP RANGE	VOLTAGE RATING	LEAD-FREE SOLDERABLE
5, 6, 7, 8, 9, 10, 11, 12, 13, 14, 15, 16, 18, 20 mm	Black LCP	Copper Alloy	Sn or Au over 50 μ" (1.27 μm) Ni	-55 °C to +105 °C with Tin -55 °C to +125 °C with Gold	460 VAC/ 651 VDC	Yes

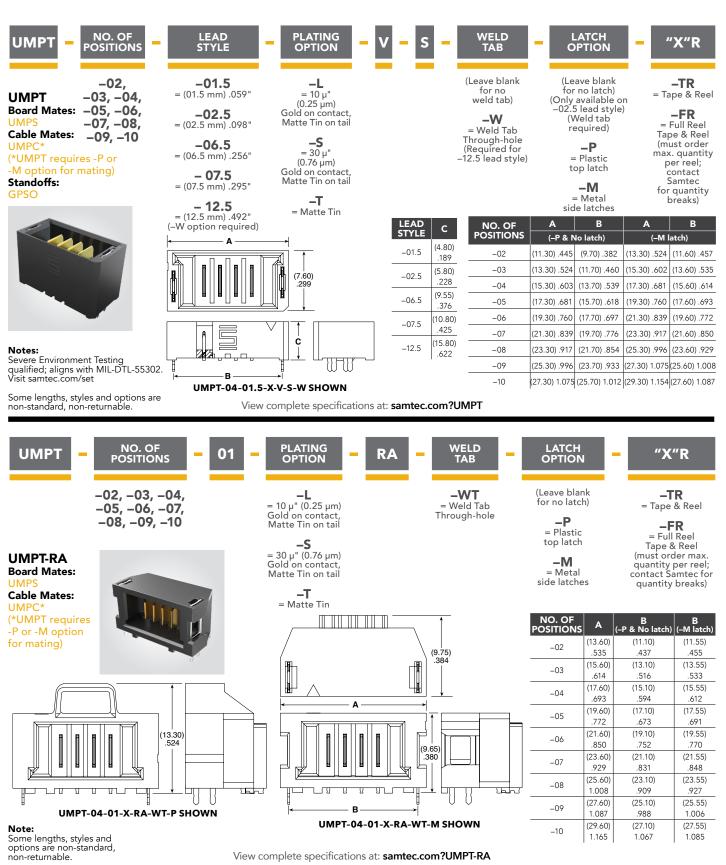
FFFFFF

samtec.com/mPOWER

Unless otherwise approved in writing by Samtec, all parts and components are designed and built according to Samtec's specifications which are subject to change without notice.

mPOWER°

ULTRA MICRO POWER TERMINAL



8

samtec.com/mPOWER

Unless otherwise approved in writing by Samtec, all parts and components are designed and built according to Samtec's specifications which are subject to change without notice.